imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



General Description

The MAX1922 current-limited 70m Ω switch with built-in fault blanking provides an accurate, preset 1.4A to 2.1A current limit, making it ideal for dual USB applications. Its low quiescent supply current (16µA) and standby current (1µA) conserve battery power in portable applications. The MAX1922 operates with inputs from 2.7V to 5.5V, making it ideal for both 3V and 5V systems.

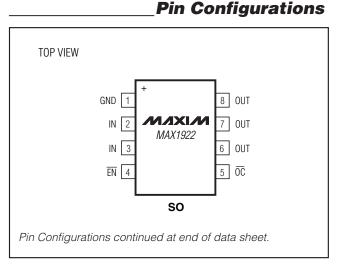
An overcurrent signal (\overline{OC}) notifies the microprocessor that the internal current limit has been reached. A 10ms overcurrent-blanking feature allows momentary faults (such as those caused when hot-swapping into a capacitive load) to be ignored, thus preventing false alarms to the host system. This blanking also prevents an \overline{OC} signal from being issued when the device is powering up.

The MAX1922 has several safety features to ensure that the USB port is protected. Built-in thermal-overload protection limits power dissipation and junction temperature. The device also has accurate internal currentlimiting circuitry to protect the input supply against overload.

The MAX1922 is offered in a space-saving 8-pin SO package and a 10-pin TDFN package and operates over the extended (-40 $^{\circ}$ C to +85 $^{\circ}$ C) temperature range.

Applications

Notebook Computers USB Ports USB Hubs Docking Stations



___ Maxim Integrated Products 1

Features A max)

OC Blanking During Power-Up 125mΩ (max) High-Side MOSFET

 Short-Circuit and Thermal Protection with Overcurrent Logic Output

Accurate Current Limit (1.4A min, 2.1A max)

♦ 10ms Internal OC Blanking Timeout

- Undervoltage Lockout
- ♦ 16µA Quiescent Supply Current
- ♦ 1µA (max) Standby Supply Current
- ♦ 2.7V to 5.5V Supply Range
- UL Recognized: UL# E211395

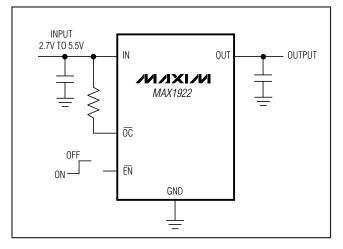
Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	TOP MARK	
MAX1922ESA+	-40°C to +85°C	8 SO		
MAX1922ETB+	-40°C to +85°C	10 TDFN-EP*	AQQ	

*EP = Exposed paddle.

+Denotes a lead(Pb)-free/RoHS-compliant package.

Typical Operating Circuit



For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

IN, EN, OC to GND	-0.3V to +6V
OUT to GND	
Maximum Switch Current	2.3A (internally limited)
OUT Short-Circuit to GND	Continuous

Continuous Power Dissipation (T_A = +70°C) 8-Pin SO (derate 5.88mW/°C above +70°C)......471mW 10-Pin TDFN (derate 18.5mW/°C above +70°C)......1481mW Operating Temperature Range (extended)......-40°C to +85°C Storage Temperature Range-65°C to +150°C Lead Temperature (soldering, 10s).....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 5V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at }T_A = +25^{\circ}C.)$

PARAMETER	SYMBOL	CON	DITIONS	MIN	ТҮР	MAX	UNITS	
OPERATING CONDITION								
Input Voltage	VIN			2.7		5.5	V	
POWER SWITCH								
		$T_A = +25^{\circ}C$	$V_{IN} = 4.4V$ to 5.5V		70	100		
Switch Static Drain-Source On- State Resistance	RDS(ON)		V _{IN} = 4.4V to 5.5V			125	mΩ	
		$T_A = 0^{\circ}C \text{ to } +85^{\circ}C$	$V_{IN} = 3V$		72	150		
Switch Turn-On Time	ton	I _{LOAD} = 400mA			80	200	μs	
Switch Turn-Off Time	toff	I _{LOAD} = 400mA		3	6	20	μs	
ENABLE INPUT (EN)								
		$V_{IN} = 2.7V$ to 3.6V		2.0			V	
EN High-Level Input Voltage	VIH	V _{IN} = 3.7V to 5.5V		2.4				
EN Low-Level Input Voltage	VIL	$V_{IN} = 2.7V$ to 5.5V	V _{IN} = 2.7V to 5.5V			0.8	V	
EN Input Current		$V_{\overline{EN}} = V_{IN} \text{ or } GND$		-1		1	μA	
Startup Time		$V_{IN} = 5V, C_{OUT} = 150\mu F$ from \overline{EN} driven low to 50% full V _{OUT}			1		ms	
CURRENT LIMIT	1	I						
Overload Output Current	ILIMIT	Force VOUT to 4.5V		1.4	1.75	2.1	А	
Short-Circuit Output Current	ISC	OUT shorted to GND			1	1.4	А	
SUPPLY CURRENT		•					<u>.</u>	
Supply Current, Low-Level Input		$V_{\overline{EN}} = V_{IN} = V_{OUT} = V_{OUT}$	5.5V		0.002	1	μΑ	
Supply Current, High-Level	1.		Timer not running		16	25		
Input	IQ	$V_{\overline{EN}} = 0, I_{OUT} = 0$	Timer running		35		μA	
		$V_{\overline{EN}} = V_{IN} = 5.5V,$	$T_A = +25^{\circ}C$		0.01	2		
Supply-Leakage Current		$V_{OUT} = 0$ $T_A = 0^{\circ}C \text{ to } +85^{\circ}C$				15	μA	
UNDERVOLTAGE LOCKOUT								
Undervoltage Lockout	UVLO	Rising edge, 100mV	hysteresis	2.0	2.4	2.6	V	
OVERCURRENT (OC)								
OC Threshold				1.1			А	
OC Output Low Voltage	VOL	I _{SINK} = 1mA, V _{IN} = 3	V			0.4	V	
		•						

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{IN} = 5V, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$

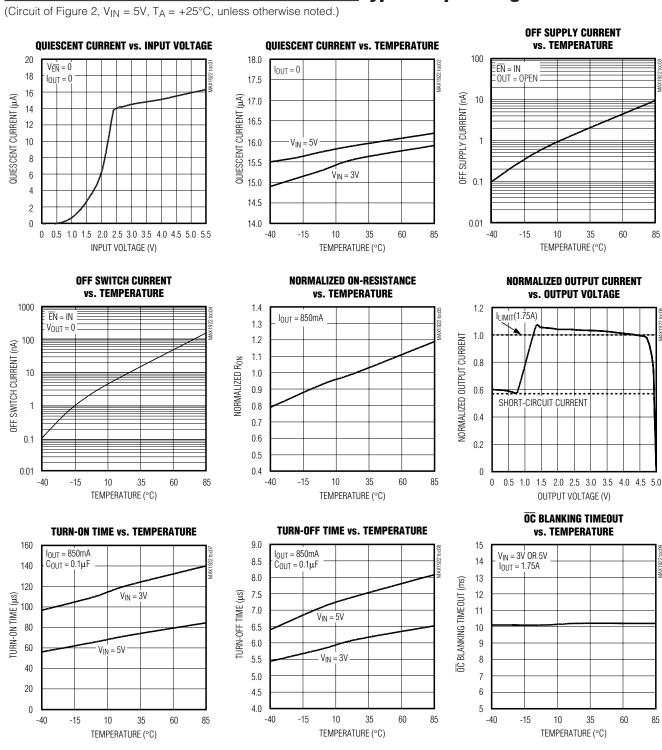
PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
OC Off-State Current		$V_{IN} = V_{\overline{OC}} = 5V$			1	μA	
OC Blanking Timeout Period t _{BL} From overcurrent co		From overcurrent condition to OC assertion	6	10	13	ms	
THERMAL SHUTDOWN							
Thermal Shutdown Threshold				165		°C	

ELECTRICAL CHARACTERISTICS

 $(V_{IN} = 5V, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.})$ (Note 1)

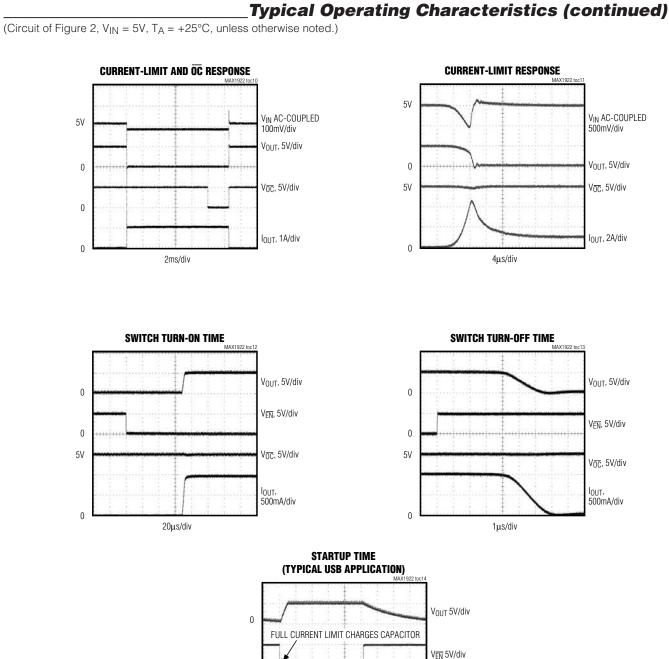
PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS
OPERATING CONDITION						•
Input Voltage	V _{IN}		3.0		5.5	V
POWER SWITCH						
Switch Static Drain-Source	5	$V_{IN} = 4.4V \text{ to } 5.5V$			125	
On-State Resistance	R _{DS(ON)}	V _{IN} = 3V			150	mΩ
Switch Turn-On Time	ton	$I_{LOAD} = 400 \text{mA}$			200	μs
Switch Turn-Off Time	tOFF	$I_{LOAD} = 400 \text{mA}$	1		20	μs
ENABLE INPUT (EN)						
	Max	V _{IN} = 3.0V to 3.6V	2.0			V
EN High-Level Input Voltage	VIH	V _{IN} = 3.7V to 5.5V	2.4			V
EN Low-Level Input Voltage	VIL	$V_{IN} = 3.0V \text{ to } 5.5V$			0.8	V
EN Input Current		V _{EN} = V _{IN} or GND	-1		1	μΑ
CURRENT LIMIT						
Overload Output Current	ILIMIT	Force V _{OUT} to 4.5V	1.2		2.3	А
Short-Circuit Output Current	Isc	OUT shorted to GND			1.5	А
SUPPLY CURRENT						
Supply Current, Low-Level Input		$V_{\overline{EN}} = V_{IN} = V_{OUT} = 5.5V$			2	μA
Supply Current, High-Level Input	IQ	$V_{\overline{EN}} = GND$, $I_{OUT} = 0$, timer not running			25	μA
Supply Leakage Current		$V_{\overline{\text{EN}}} = V_{\text{IN}} = 5.5V, V_{\text{OUT}} = \text{GND}$			15	μA
UNDERVOLTAGE LOCKOUT	•		•			
Undervoltage Lockout	UVLO	Rising edge, 100mV hysteresis	2.0		2.9	V
OVERCURRENT (OC)						
OC Threshold			1.1			А
OC Output Low Voltage	Vol	I _{SINK} = 1mA, V _{IN} = 3V			0.4	V
OC Off-State Current		$V_{IN} = V_{\overline{OC}} = 5V$			1	μA
OC Blanking Timeout Period	t _{BL}	From overcurrent condition to OC assertion	6		14	ms

Note 1: Specifications to -40°C are guaranteed by design, not production tested.



Typical Operating Characteristics

MAX1922



RESISTOR LOAD CURRENT

I_{IN} 1A/div

Voc 5A/div

0

0

5V

SHORT-CIRCUIT

CURRENT LIMIT

1ms/div

MAX1922

Pin Description

PACKAGE		NAME	FUNCTION			
TDFN	SO	NAME	FUNCTION			
6	1	GND	Ground			
1, 3, 9	2, 3	IN	Input. p-channel MOSFET source—connect all IN pins together and bypass with a 1µF capacitor ground.			
5	4	ĒN	Active-Low Switch Enable Input. A logic-low turns on the switch.			
7	5	OC	Overcurrent-Indicator Output. This open-drain output goes low when the device is in thermal shutdown or undervoltage lockout, or during a sustained (10ms) current-limit condition.			
2, 4, 8, 10	6, 7, 8	OUT	Switch Output. p-channel MOSFET drain—connect all OUT pins together and bypass with a 0.1μ F capacitor to ground.			
EP		EP	TDFN Only. Exposed paddle. Connect to the GND plane for optimum thermal dissipation. This does not remove the requirement for a proper ground.			

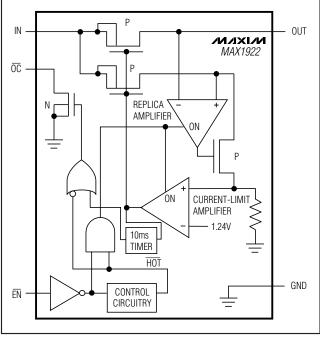


Figure 1. Functional Diagram

Detailed Description

The MAX1922 p-channel MOSFET power switch limits output current to 1.4A min and 2.1A max. When the output current increases beyond the current limit (I_{LIMIT}), the current also increases through the replica switch (I_{OUT} / 13000). The current-limit error amplifier compares the voltage to the internal 1.24V reference and regulates the current back to the I_{LIMIT} (Figure 1).

These switches are not bidirectional; therefore, the input voltage must be higher than the output voltage.

Continuous Short-Circuit Protection

The MAX1922 is a short-circuit-protected switch. In the event of an output short-circuit condition, the current through the switch is foldback-current-limited to 1A continuous.

Thermal Shutdown

The MAX1922 has a thermal shutdown feature. The switch turns off and the \overline{OC} output goes low immediately (no overcurrent blanking) when the junction temperature exceeds +165°C. When the MAX1922 cools 20°C, the switch turns back on. If the fault short-circuit condition is not removed, the switch cycles on and off, resulting in a pulsed output.

OC Indicator

The MAX1922 provides an overcurrent output (\overline{OC}). A 100k Ω pullup resistor from \overline{OC} to IN provides a logic control signal. This open-drain output goes low when any of the following conditions occur:

- The input voltage is below the 2.4V undervoltage lockout (UVLO) threshold.
- The die temperature exceeds the thermal shutdown temperature limit of +165°C.
- The device is in current limit for greater than 10ms.

OC Blanking

The MAX1922 features 10ms overcurrent blanking. Blanking allows brief current-limit faults, including momentary short-circuit faults that occur when hotswapping a capacitive load, and ensures that no \overline{OC} is issued during power-up. When a load transient causes the device to enter current limit, an internal counter starts. If the load fault persists beyond the 10ms overcurrent blanking timeout, the \overline{OC} output asserts low. Ensure that the MAX1922 input is adequately bypassed to prevent input glitches from triggering spurious \overline{OC}



MAX1922

outputs. Input voltage glitches less than 150mV do not cause a spurious \overrightarrow{OC} output. Load-transient faults less than 10ms (typ) will not cause an \overrightarrow{OC} output assertion.

Only current-limit faults are blanked. Die overtemperature faults and input voltage droops below the UVLO threshold will cause an immediate OC output.

Applications Information

Input Capacitor

To limit the input voltage drop during momentary output short-circuit conditions, connect a capacitor from IN to GND. A 1 μ F ceramic capacitor is adequate for most applications; however, higher capacitor values further reduce the voltage drop at the input (Figure 2).

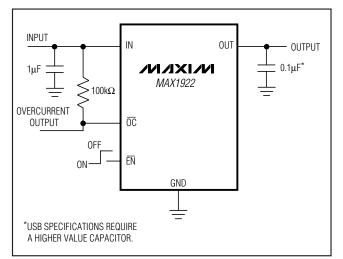


Figure 2. Typical Application Circuit

Output Capacitor

Connect a 0.1μ F capacitor from OUT to GND. This capacitor helps to prevent inductive parasitics from pulling OUT negative during turn-off.

Layout and Thermal Dissipation

Important: Optimize the switch response time to output short-circuit conditions by keeping all traces as short as possible to reduce the effect of undesirable parasitic inductance. Place input and output capacitors as close as possible to the device (no more than 5mm away). All IN and OUT pins must be connected with short traces to the power bus. Wide power-bus planes provide superior heat dissipation through the MAX1922's IN and OUT pins. Under normal operating conditions, the package can dissipate and channel heat away. Calculate the maximum power dissipation as follows:

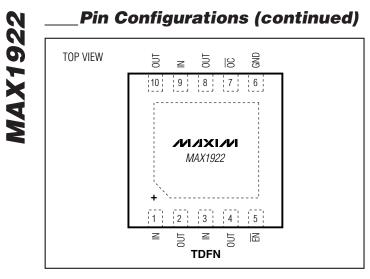
$$P = (I_{LIMIT})^2 \times R_{ON}$$

where I_{LIMIT} is the preset current limit (2.1A max) and R_{ON} is the on-resistance of the switch (125m Ω max).

When the output is short circuited, foldback-current limiting activates and the voltage drop across the switch equals the input supply voltage. The power dissipated across the switch increases, as does the die temperature. If the fault condition is not removed, the thermaloverload protection circuitry activates (see *Thermal Shutdown* section). Wide power-bus planes connected to IN and OUT and a ground plane in contact with the device help dissipate additional heat.

Driving Inductive Loads

A wide variety of devices (mice, keyboards, cameras, and printers) can load the USB port. These devices commonly connect to the port with cables, which can add an inductive component to the load. This inductance causes the output voltage at the USB port to ring during a load step. The MAX1922 is capable of driving inductive loads, but avoid exceeding the device's absolute maximum ratings. Usually the load inductance is relatively small, and the MAX1922 input includes a substantial bulk capacitance from an upstream regulator as well as local bypass capacitors, limiting overshoot. If severe ringing occurs due to large load inductance, clamp the MAX1922 output below 6V and above -0.3V.



Chip Information

PROCESS: BiCMOS

Package Information

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
8 SO	S8-5	<u>21-0041</u>
10 TDFN-EP	T1033-1	<u>21-0137</u>

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	
3	4/09	Fixed typo in UL #	1

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

Maxim Integrated Products, 120 San Gabriel Drive, Sunnyvale, CA 94086 408-737-7600

_____ 9